



承认书

Approval Sheet

客户名称:

Customer

/

产品名称:

屏蔽贴片功率电感器

Part Name

Shielded Smt Power Inductors

产品规格:

Specification

JRH2D~6D Series

版本号:

Version No.

A/0

日期:

Date

2020-7-3

制造Manufacturer			客户Customer		
拟制	审核	确认	检验	审核	批准
Draft by	Checked by	Approve by	Check by	Checked by	Approval by
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履 历 表 Resume

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产品指南Products Guide

Description	Model	P/N	Package Size	Inductance Range(uH)	Saturation Current(A)Max	Temperature Rise Current(A)Max
Shielded Smt Power Inductors 屏蔽贴片功率电感器		JRH	2D09	1.2-10	0.28-0.8	0.42-1.24
			2D11	1.2-10	0.48-1.25	0.35-0.9
			2D14	1.5-12	0.62-1.8	0.64-2
			2D18	2.2-47	0.2-0.85	0.48-2.3
			3D11	2.7-39	0.15-0.53	0.35-1.82
			3D14	1.2-22	0.52-2.15	0.43-2.2
			3D16	1.5-33	0.32-1.55	0.41-2.4
			3D28	3.3-47	0.48-2	0.56-1.85
			4D18	1-33	0.3-1.72	0.3-1.72
			4D28	1.2-180	0.22-2.56	0.22-2.56
			5D18	5.4-100	0.36-1.6	0.36-1.6
			5D28	3-100	0.42-2.4	0.42-2.4
			6D28	3.3-100	0.54-3	0.54-3
			6D38	3.3-100	0.62-3.5	0.62-3.5

Characteristics特征

- 高饱和电流，低直流电阻；
- 闭合磁路设计减少漏磁；
- 适用于表面贴装设备；
- 多种封装尺寸和宽电感范围。

Application应用

- 录影机；
- OA设备；
- 笔记本电脑；
- 小型通信机器；
- DC/DC转换器DSC,DVC,MP3,PDA,产品等。

形状和尺寸 Shape And Dimensions (Unit: mm)

Fig.1

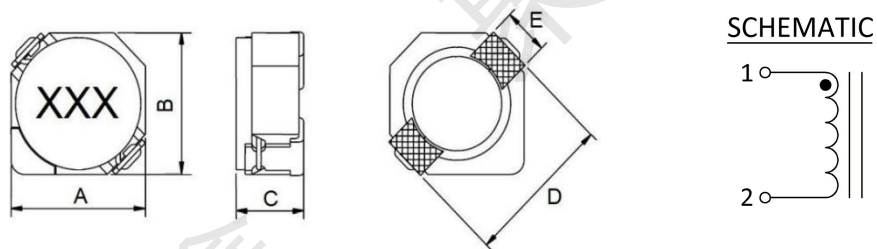
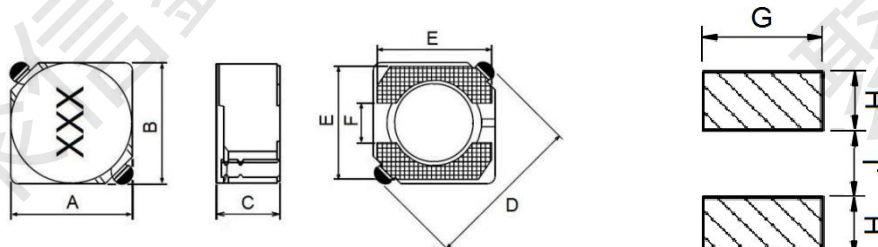


Fig.2



Part No	ITEM									
	Shape	A	B	C	D	E	F	G	H	J
JRH2D09	Fig.1	3.2 Max	3.2 Max	1.1 Max	4.2 Max	3.3 Max	2.1	1.3	1.3	1.7
JRH2D11	Fig.1	3.2 Max	3.2 Max	1.3 Max	4.2 Max	3.3 Max	2.1	1.3	1.3	1.7
JRH2D14	Fig.1	3.2 Max	3.2 Max	1.6 Max	4.2 Max	3.3 Max	2.1	1.3	1.3	1.7
JRH2D18	Fig.1	3.2 Max	3.2 Max	2.0 Max	4.2 Max	3.3 Max	2.1	1.3	1.3	1.7
JRH3D11	Fig.2	4.0 Max	4.0 Max	1.4 Max	5.5 Max	3.7 Max	1.2	4.5	1.5	1.2
JRH3D14	Fig.2	4.0 Max	4.0 Max	1.7 Max	5.5 Max	3.7 Max	1.2	4.5	1.5	1.2
JRH3D16	Fig.2	4.0 Max	4.0 Max	2.0 Max	5.5 Max	3.7 Max	1.2	4.5	1.5	1.2
JRH3D28	Fig.2	4.0 Max	4.0 Max	3.1 Max	5.5 Max	3.7 Max	1.2	4.5	1.5	1.2
JRH4D18	Fig.2	5.0 Max	5.0 Max	2.0 Max	6.9 Max	4.5 Max	1.5	5.3	1.9	1.5
JRH4D28	Fig.2	5.0 Max	5.0 Max	3.0 Max	6.9 Max	4.5 Max	1.5	5.3	1.9	1.5
JRH5D18	Fig.2	6.0 Max	6.0 Max	2.0 Max	8.2 Max	5.5 Max	2	6.3	2.15	2
JRH5D28	Fig.2	6.0 Max	6.0 Max	3.0 Max	8.2 Max	5.5 Max	2	6.3	2.15	2
JRH6D28	Fig.2	7.0 Max	7.0 Max	3.0 Max	9.5 Max	6.5 Max	2	7.3	2.65	2
JRH6D38	Fig.2	7.0 Max	7.0 Max	4.0 Max	9.5 Max	6.5 Max	2	7.3	2.65	2

Product Spec. Model产品品名构成

JRH 5D28 220 M
(1) (2) (3) (4)

(1)Product symbol系列代号

(2)Dimensions外形尺寸

(3)Inductance电感量: 1R0:1.0 μ H 100:10 μ H 101:100 μ H;

(4)Tolerance公差: J/K/L/M/N 5% /10% /15% /20% /30%;

Specifications规格

JRH2D09 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH2D09-1R2N	1.2	N	100KHz	0.097	0.8	1.24
JRH2D09-1R5N	1.5	N	100KHz	0.11	0.73	1.15
JRH2D09-1R8N	1.8	N	100KHz	0.131	0.65	1.06
JRH2D09-2R2N	2.2	N	100KHz	0.143	0.6	1.05
JRH2D09-2R7N	2.7	N	100KHz	0.15	0.53	0.98
JRH2D09-3R3N	3.3	N	100KHz	0.193	0.47	0.84
JRH2D09-3R9N	3.9	N	100KHz	0.225	0.45	0.72
JRH2D09-4R7N	4.7	N	100KHz	0.287	0.41	0.64
JRH2D09-5R6N	5.6	N	100KHz	0.325	0.37	0.59
JRH2D09-6R8N	6.8	N	100KHz	0.425	0.33	0.53
JRH2D09-8R2N	8.2	N	100KHz	0.475	0.3	0.46
JRH2D09-100N	10	M	100KHz	0.537	0.28	0.42

JRH2D11 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH2D11-1R2N	1.2	N	100KHz	0.068	1.25	0.9
JRH2D11-2R2N	2.2	N	100KHz	0.098	1.1	0.78
JRH2D11-3R3N	3.3	N	100KHz	0.123	0.88	0.6
JRH2D11-4R7N	4.7	N	100KHz	0.17	0.7	0.5
JRH2D11-6R8N	6.8	N	100KHz	0.26	0.6	0.44
JRH2D11-100N	10	N	100KHz	0.4	0.48	0.35

JRH2D14 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH2D14-1R5N	1.5	N	100KHz	0.063	1.8	2
JRH2D14-1R8N	1.8	N	100KHz	0.075	1.65	1.8
JRH2D14-2R2N	2.2	N	100KHz	0.094	1.5	1.6
JRH2D14-2R7N	2.7	N	100KHz	0.106	1.35	1.4
JRH2D14-3R3N	3.3	N	100KHz	0.125	1.2	1.25
JRH2D14-3R9N	3.9	N	100KHz	0.138	1.1	1.12
JRH2D14-4R7N	4.7	N	100KHz	0.185	1	1
JRH2D14-5R6N	5.6	N	100KHz	0.22	0.95	0.98
JRH2D14-6R8N	6.8	N	100KHz	0.25	0.85	0.92
JRH2D14-8R2N	8.2	N	100KHz	0.281	0.8	0.8
JRH2D14-100N	10	N	100KHz	0.318	0.65	0.76
JRH2D14-120M	12	M	100KHz	0.438	0.62	0.64

JRH2D18 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH2D18-2R2N	2.2	N	100KHz	0.041	0.85	2.3
JRH2D18-3R3N	3.3	N	100KHz	0.054	0.75	2.1
JRH2D18-4R7N	4.7	N	100KHz	0.078	0.63	1.65
JRH2D18-6R8N	6.8	N	100KHz	0.106	0.52	1.32
JRH2D18-100N	10	N	100KHz	0.18	0.43	1
JRH2D18-150 M	15	M	100KHz	0.22	0.35	0.8
JRH2D18-220 M	22	M	100KHz	0.32	0.3	0.68
JRH2D18-330 M	33	M	100KHz	0.46	0.24	0.56
JRH2D18-470 M	47	M	100KHz	0.66	0.2	0.48

JRH3D11 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH3D11-2R7N	2.7	N	100KHz	0.078	0.53	1.82
JRH3D11-3R3N	3.3	N	100KHz	0.099	0.45	1.38
JRH3D11-4R7N	4.7	N	100KHz	0.156	0.4	1.05
JRH3D11-6R8N	6.8	N	100KHz	0.225	0.34	0.9
JRH3D11-8R2N	8.2	N	100KHz	0.294	0.32	0.8
JRH3D11-100N	10	N	100KHz	0.338	0.28	0.68
JRH3D11-120 M	12	M	100KHz	0.418	0.25	0.58
JRH3D11-150 M	15	M	100KHz	0.55	0.23	0.53
JRH3D11-180 M	18	M	100KHz	0.626	0.21	0.48
JRH3D11-220 M	22	M	100KHz	0.731	0.19	0.41
JRH3D11-330 M	33	M	100KHz	1.108	0.17	0.38
JRH3D11-390 M	39	M	100KHz	1.39	0.15	0.35

JRH3D14 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μ H)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH3D14-1R2N	1.2	N	100KHz	45	2.15	2.2
JRH3D14-1R7N	1.7	N	100KHz	0.063	1.85	2
JRH3D14-2R2N	2.2	N	100KHz	0.069	1.6	1.75
JRH3D14-2R7N	2.7	N	100KHz	0.088	1.45	1.36
JRH3D14-3R3N	3.3	N	100KHz	0.1	1.35	1.24
JRH3D14-3R9N	3.9	N	100KHz	0.135	1.15	1.12
JRH3D14-4R7N	4.7	N	100KHz	0.15	1.1	0.96
JRH3D14-8R2N	8.2	N	100KHz	0.238	0.82	0.74
JRH3D14-100N	10	N	100KHz	0.262	0.75	0.69
JRH3D14-120 M	12	M	100KHz	0.35	0.67	0.6
JRH3D14-150 M	15	M	100KHz	0.488	0.6	0.58
JRH3D14-220 M	22	M	100KHz	0.575	0.52	0.43

JRH3D16 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH3D16-1R5N	1.5	N	100KHz	0.052	1.55	2.4
JRH3D16-2R2N	2.2	N	100KHz	0.072	1.2	2
JRH3D16-3R3N	3.3	N	100KHz	0.085	1.1	1.8
JRH3D16-4R7N	4.7	N	100KHz	0.105	0.9	1.5
JRH3D16-6R8N	6.8	N	100KHz	0.17	0.73	1.1
JRH3D16-100N	10	N	100KHz	0.21	0.55	1
JRH3D16-150 M	15	M	100KHz	0.295	0.45	0.75
JRH3D16-220 M	22	M	100KHz	0.43	0.4	0.52
JRH3D16-330 M	33	M	100KHz	0.675	0.32	0.41

JRH3D28 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH3D28-3R3N	3.3	N	100KHz	0.072	2	1.85
JRH3D28-4R7N	4.7	N	100KHz	0.088	1.65	1.62
JRH3D28-6R8N	6.8	N	100KHz	0.119	1.24	1.32
JRH3D28-8R2N	8.2	N	100KHz	0.132	1.15	1.2
JRH3D28-100N	10	N	100KHz	0.145	1.05	1.18
JRH3D28-150 M	15	M	100KHz	0.213	0.9	1.02
JRH3D28-220 M	22	M	100KHz	0.335	0.76	0.74
JRH3D28-330 M	33	M	100KHz	0.481	0.58	0.63
JRH3D28-470 M	47	M	100KHz	0.599	0.48	0.56

JRH4D18 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH4D18-1R0N	1	N	100KHz	0.045	1.72	1.72
JRH4D18-2R2N	2.2	N	100KHz	0.075	1.32	1.32
JRH4D18-2R7N	2.7	N	100KHz	0.105	1.28	1.28
JRH4D18-3R3N	3.3	N	100KHz	0.11	1.04	1.04
JRH4D18-3R9N	3.9	N	100KHz	0.155	0.88	0.88
JRH4D18-4R7N	4.7	N	100KHz	0.162	0.84	0.84
JRH4D18-5R6N	5.6	N	100KHz	0.17	0.8	0.8
JRH4D18-8R2N	8.2	N	100KHz	0.245	0.68	0.68
JRH4D18-100N	10	N	100KHz	0.21	0.56	0.56
JRH4D18-120 M	12	M	100KHz	0.24	0.5	0.5
JRH4D18-150 M	15	M	100KHz	0.338	0.48	0.48
JRH4D18-180 M	18	M	100KHz	0.397	0.41	0.41
JRH4D18-220 M	22	M	100KHz	0.441	0.35	0.35
JRH4D18-270 M	27	M	100KHz	0.694	0.32	0.32
JRH4D18-330 M	33	M	100KHz	0.709	0.3	0.3

JRH4D28 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH4D28-1R2N	1.2	N	100KHz	0.023	2.56	2.56
JRH4D28-1R8N	1.8	N	100KHz	0.027	2.2	2.2
JRH4D28-2R2N	2.2	N	100KHz	0.031	2.04	2.04
JRH4D28-2R7N	2.7	N	100KHz	0.043	1.6	1.6
JRH4D28-3R3N	3.3	N	100KHz	0.049	1.57	1.57
JRH4D28-3R9N	3.9	N	100KHz	0.064	1.44	1.44
JRH4D28-4R7N	4.7	N	100KHz	0.072	1.32	1.32
JRH4D28-5R6N	5.6	N	100KHz	0.397	0.41	0.41
JRH4D28-6R8N	6.8	N	100KHz	0.441	0.35	0.35
JRH4D28-8R2N	8.2	N	100KHz	0.694	0.32	0.32
JRH4D28-100N	10	N	100KHz	0.709	0.3	0.3

JRH4D28 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH4D28-120 M	12	M	100KHz	0.131	0.84	0.84
JRH4D28-150 M	15	M	100KHz	0.149	0.76	0.76
JRH4D28-180 M	18	M	100KHz	0.166	0.72	0.72
JRH4D28-220 M	22	M	100KHz	0.235	0.7	0.7
JRH4D28-270 M	27	M	100KHz	0.261	0.58	0.58
JRH4D28-330 M	33	M	100KHz	0.378	0.56	0.56
JRH4D28-390 M	39	M	100KHz	0.383	0.5	0.5
JRH4D28-470 M	47	M	100KHz	0.587	0.48	0.48
JRH4D28-560 M	56	M	100KHz	0.624	0.41	0.41
JRH4D28-680 M	68	M	100KHz	0.699	0.35	0.35
JRH4D28-820 M	82	M	100KHz	0.914	0.32	0.32
JRH4D28-101 M	100	M	100KHz	1.102	0.29	0.29
JRH4D28-121 M	120	M	100KHz	1.127	0.27	0.27
JRH4D28-151 M	150	M	100KHz	1.135	0.24	0.24
JRH4D28-181M	180	M	100KHz	1.154	0.22	0.22

JRH5D18 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH5D18-5R4N	5.4	N	10KHz	0.076	1.6	1.6
JRH5D18-6R2N	6.2	N	10KHz	0.096	1.4	1.4
JRH5D18-8R9N	8.9	N	10KHz	0.116	1.25	1.25
JRH5D18-100N	10	N	10KHz	0.124	1.2	1.2
JRH5D18-120 M	12	M	10KHz	0.153	1.1	1.1
JRH5D18-150 M	15	M	10KHz	0.196	0.97	0.97
JRH5D18-180 M	18	M	10KHz	0.21	0.85	0.85
JRH5D18-220 M	22	M	10KHz	0.29	0.8	0.8
JRH5D18-270 M	27	M	10KHz	0.33	0.75	0.75
JRH5D18-330 M	33	M	10KHz	0.386	0.65	0.65
JRH5D18-390 M	39	M	10KHz	0.52	0.57	0.57
JRH5D18-470 M	47	M	10KHz	0.595	0.54	0.54
JRH5D18-560 M	56	M	10KHz	0.665	0.5	0.5
JRH5D18-680 M	68	M	10KHz	0.84	0.43	0.43
JRH5D18-820 M	82	M	10KHz	0.978	0.41	0.41
JRH5D18-101 M	100	M	10KHz	1.2	0.36	0.36

JRH5D28 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH5D28-3R0N	3	N	10KHz	0.024	2.4	2.4
JRH5D28-4R2N	4.2	N	10KHz	0.031	2.2	2.2
JRH5D28-5R3N	5.3	N	10KHz	0.038	1.9	1.9
JRH5D28-6R2N	6.2	N	10KHz	0.045	1.8	1.8
JRH5D28-8R2N	8.2	N	10KHz	0.053	1.6	1.6
JRH5D28-100N	10	N	10KHz	0.065	1.3	1.3
JRH5D28-120 M	12	M	10KHz	0.076	1.2	1.2
JRH5D28-150 M	15	M	10KHz	0.403	1.1	1.1
JRH5D28-180 M	18	M	10KHz	0.11	1	1
JRH5D28-220 M	22	M	10KHz	0.122	0.9	0.9
JRH5D28-270 M	27	M	10KHz	0.175	0.85	0.85
JRH5D28-330 M	33	M	10KHz	0.189	0.75	0.75
JRH5D28-390 M	39	M	10KHz	0.212	0.7	0.7
JRH5D28-470 M	47	M	10KHz	0.26	0.62	0.62
JRH5D28-560 M	56	M	10KHz	0.305	0.58	0.58
JRH5D28-680 M	68	M	10KHz	0.355	0.52	0.52
JRH5D28-820 M	82	M	10KHz	0.463	0.46	0.46
JRH5D28-101 M	100	M	10KHz	0.52	0.42	0.42

JRH6D28 Series

Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tole	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH6D28-3R0N	3.3	N	10KHz	0.024	3	3
JRH6D28-3R9N	3.9	N	10KHz	0.027	2.6	2.6
JRH6D28-5R0N	5	N	10KHz	0.031	2.42	2.42
JRH6D28-6R0N	6	N	10KHz	0.035	2.25	2.25
JRH6D28-7R3N	7.3	N	10KHz	0.054	2.1	2.1
JRH6D28-8R6N	8.6	N	10KHz	0.058	1.85	1.85
JRH6D28-100N	10	N	10KHz	0.065	1.7	1.7
JRH6D28-120 M	12	M	10KHz	0.07	1.55	1.55
JRH6D28-150 M	15	M	10KHz	0.084	1.4	1.4

JRH6D28 Series

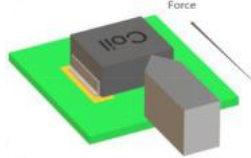
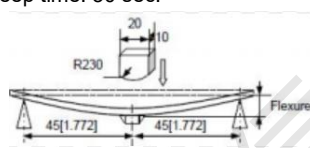
Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tolerance	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH6D28-180 M	18	M	10KHz	0.095	1.32	1.32
JRH6D28-220 M	22	M	10KHz	0.128	1.2	1.2
JRH6D28-270 M	27	M	10KHz	0.142	1.05	1.05
JRH6D28-330 M	33	M	10KHz	0.165	0.97	0.97
JRH6D28-390 M	39	M	10KHz	0.21	0.86	0.86
JRH6D28-470 M	47	M	10KHz	0.238	0.8	0.8
JRH6D28-560M	56	M	10KHz	0.277	0.73	0.73
JRH6D28-680 M	68	M	10KHz	0.304	0.65	0.65
JRH6D28-820 M	82	M	10KHz	0.39	0.6	0.6
JRH6D28-101 M	100	M	10KHz	0.535	0.54	0.54

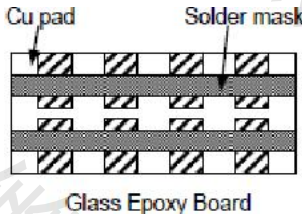
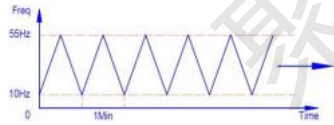
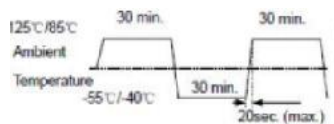
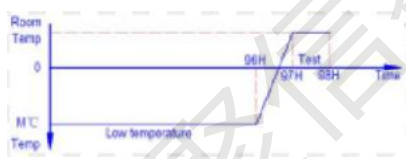
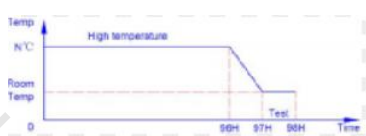
JRH6D38 Series

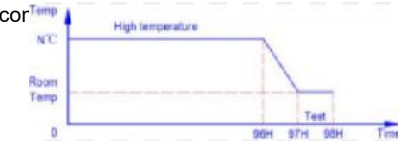
Part No	Inductance			DCR	Saturation Current	Temperature Rise Current
	L(μH)'@0A	Tolerance	TestFreq	(Ω)Max	(A)Max	(A)Max
JRH6D38-3R3N	3.3	N	10KHz	0.02	3.5	3.5
JRH6D38-5R0N	5	N	10KHz	0.024	2.9	2.9
JRH6D38-6R2N	6.2	N	10KHz	0.027	2.4	2.4
JRH6D38-7R4N	7.4	N	10KHz	0.031	2.3	2.3
JRH6D38-8R7N	8.7	N	10KHz	0.034	2.2	2.2
JRH6D38-100N	10	N	10KHz	0.038	2	2
JRH6D38-120M	12	M	10KHz	0.053	1.7	1.7
JRH6D38-150 M	15	M	10KHz	0.057	1.6	1.6
JRH6D38-180 M	18	M	10KHz	0.092	1.5	1.5
JRH6D38-220 M	22	M	10KHz	0.096	1.3	1.3
JRH6D38-270 M	27	M	10KHz	0.109	1.2	1.2
JRH6D38-330 M	33	M	10KHz	0.124	1.1	1.1
JRH6D38-390 M	39	M	10KHz	0.138	1	1
JRH6D38-470 M	47	M	10KHz	0.155	0.95	0.95
JRH6D38-560 M	56	M	10KHz	0.202	0.85	0.85
JRH6D38-680 M	68	M	10KHz	0.234	0.75	0.75
JRH6D38-820 M	82	M	10KHz	0.324	0.7	0.7
JRH6D38-101 M	100	M	10KHz	0.358	0.62	0.62

- Saturation Current: DC current at which inductance drops 35% from its value without current.
- Temperature Rise Current: the actual value of DC current when the temperature rise is $\Delta T = 40^{\circ}\text{C}$ ($T_a = 25^{\circ}\text{C}$).
- Rated DC Current: The less value which is I_{sat} or I_{rms} .
- Special remind: Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

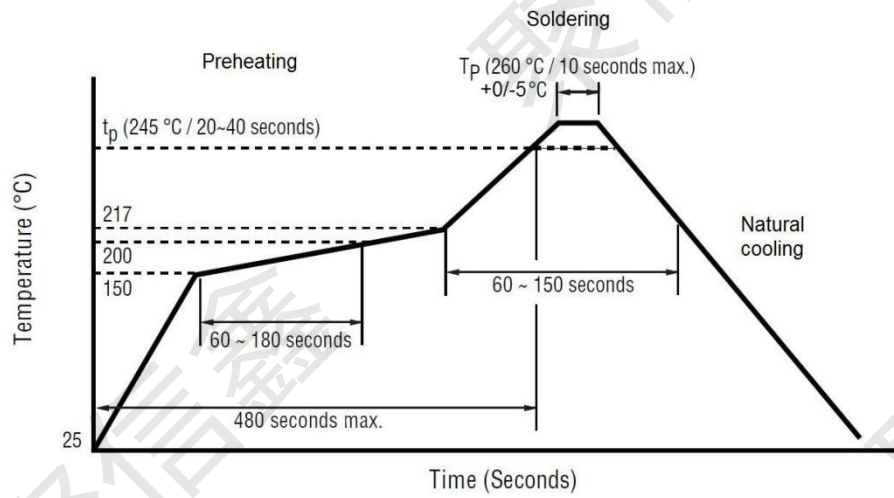
可靠性测试 Reliability testing

Items	Requirements	Test Methods and Remarks
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(SMT)	1. Pulling test: Define: A: sectional area of terminal $A \leq 8\text{mm}^2$ force $\geq 5\text{N}$ time: 30sec $8\text{mm}^2 < A \leq 20\text{mm}^2$ force $\geq 10\text{N}$ time: 10sec $20\text{mm}^2 < A$ force $\geq 20\text{N}$ time: 10sec 2. Solder paste thickness: 0.12mm 3. Meet the above requirements without any loose terminal	Solder the inductor to the testing jig using leadfree solder. Then apply a force in the direction shown Keep time: $10 \pm 1\text{s}$ Speed: 1.0mm/s. 
Terminal Strength Reference documents: GB/T 2423.60-2008 端子强度(DIP)	1. Terminal diameter(d) mm $0.35 < d \leq 0.50$ Applied force: 5N Duration: 10sec 2. Terminal diameter(d) mm $0.50 < d \leq 0.80$ Applied force: 10N Duration: 10sec 3. Terminal diameter(d) mm $0.80 < d \leq 1.25$ Applied force: 20N Duration: 10sec 4. Terminal diameter(d) mm $D > 1.25$ Applied force: 40N Duration: 10sec 5. Meet the above requirements without any loose terminal.	Pull Force: the force shall be applied gradually to the terminal and then maintained for 10 seconds. 
Resistance to Flexure JIS C 5321:1997 抗弯曲性试验	1. No visible mechanical damage.	1. Solder the inductor to the test jig (glass epoxy board) 2. shown in Using a leadfree solder. Then apply a force in the direction shown 3. Flexure: 2mm. 4. Pressurizing Speed: 0.5mm/sec. 5. Keep time: 30 sec. 
Dropping Reference documents: GB/T 2423.7-2018 落下试验	1. No case deformation or change in appearance. 2. No short and no open.	1. Drop the packaged products from 1m high in 1 angle, 3 ridges and 6 surfaces, twice in each direction.
Solderability Reference documents: GB/T 2423.28-2005 可焊性试验	1. No visible mechanical damage. 2. Wetting shall exceed 75% coverage for 3. Terminals must have 95% minimum solder coverage	1. Solder temperature: $240 \pm 2^\circ\text{C}$ 2. Duration: 3 sec. 3. Solder: Sn/3.0Ag/0.5Cu. 4. Flux: 25% Resin and 75% ethanol in weight

Items	Requirements	Test Methods and Remarks
Vibration Reference documents: GB/T 2423.10-2019 振动 试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$. 3.Q factor change: Within $\pm 20\%$. 	1.Solder the inductor to the testing jig (glass epoxy board shown in) using leadfree solder. 2.The inductor shall be subjected to a simple harmonic motion having total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 and 55 Hz. 3.The frequency range from 10 to 55 Hz and return to 10 Hz shall be traversed in approximately 1 minute. This motion shall be applied for a period of 2 hours in each 3 mutually perpendicular directions (total of 6 hours). 
Thermal Shock Reference documents: GB/T 2423.22-2012 Method Na 冷热冲击 试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$. (Mn-Zn: Within $\leq 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Start at (85~125℃) for T time, rush to (-55~40℃) for T time as one cycle, go through 100 cycles. 2.Transforming interval: Max. 20 sec. 3.Tested cycle: 100 cycles. 4.The chip shall be stabilized at normal condition for 1~2 hours 
Low temperature Storage Reference documents: GB/T 2423.1-2008 Method Ab 低温储存试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$. (Mn-Zn: Within $\leq 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature: M(-55~-40$\pm 2^{\circ}\text{C}$) 2.Duration: 96± 2 hours 3.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 
High temperature Storage Reference documents: GB/T 2423.2-2008 Method Bb 高温储存试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$. (Mn-Zn: Within $\leq 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature: N(125~85$\pm 2^{\circ}\text{C}$) 2.Duration: 96± 2 hours 3.The chip shall be stabilized at normal condition for 1~2 hours before measuring. 

Items	Requirements	Test Methods and Remarks
Damp Heat (Steady States) Reference documents: GB/T 2423.3-2016 恒定湿热试验	1.No visible mechanical damage. 2. Inductance change: Within $\pm 10\%$.(Mn-Zn: Within $\leq 30\%$) 3.Q factor change: Within $\pm 20\%$.	1.Temperature: $60 \pm 2^\circ\text{C}$ 2.Humidity: 90% to 95% RH. 3.Duration: 96 ± 2 hours. 4.The chip shall be stabilized at normal 
Heat endurance of Reflow soldering Reference documents: GJB 360B-2009 回流焊耐热性试验	1.No significant defects in appearance. 2. $\Delta L/L \leq 10\%$ (Mn-Zn: $\Delta L/L \leq 30\%$) 3. $\Delta Q/Q \leq 30\%$ (SMD series only) 4. $\Delta DCR/DCR \leq 10\%$	1.Refer to the above reflow curve and go through the reflow for twice. 2.The peak temperature : $260 \pm 0/-5^\circ\text{C}$
Resistance to solvent test Reference documents: IEC 68-2-45:1993 耐溶剂性试验	No case deformation or change in appearance or obliteration of marking	To dip parts into IPA solvent for 5 ± 0.5 Min,then drying them at room temp for 5Min,at last ,to brushing making 10 times.
Overload test Reference documents: JIS C5311-6.13 过负荷试验	1.During the test no smoke, no peculiar, smell, no fire 2.The characteristic is normal after test	Apply twice as rated current for 5 minutes.
voltage resistance test Reference documents: MIL-STD-202G Method 301 绝缘耐压测试	1.During the test no breakdown 2.The characteristic is normal after test	1. For parts with two coils 2. DC1000V, Current: 1mA, Time: 1Min. 3. Refer to catalogue of specific products

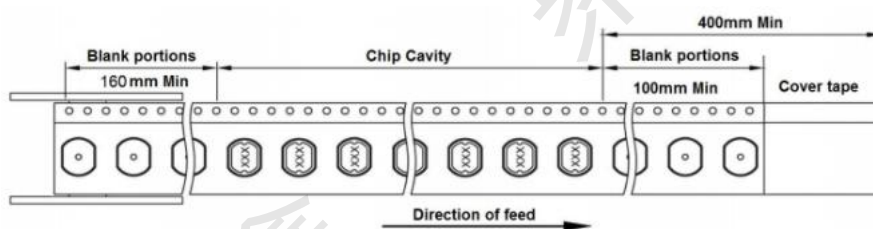
推荐回流焊温度曲线 Recommended reflow soldering curve:



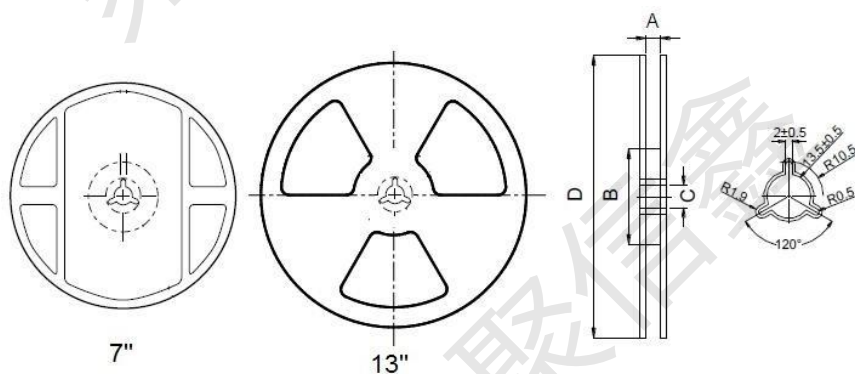
The recommended reflow conditions as above graph, is set according to our soldering equipment. DUE to various manufactures may have different reflow soldering equipment, products, process conditions, set methods. And so on, when setting the reflow conditions, Please adjust and confirm according to users' environment/equipment.

产品包装 Packaging

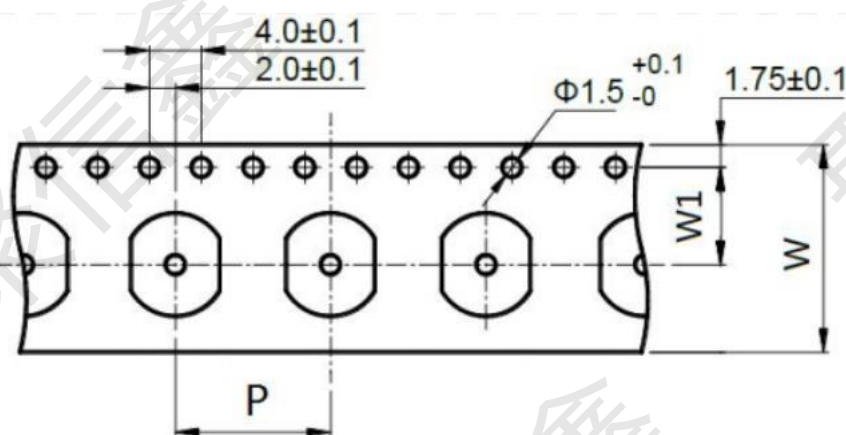
Tape and Reel Specifications: (Dimensions are in mm)



Reel Dimensions (mm)



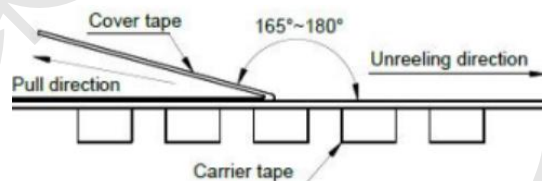
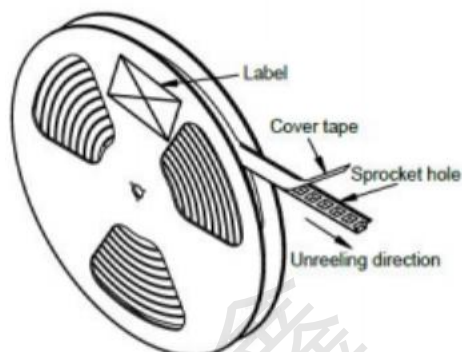
Tape Dimension (mm)



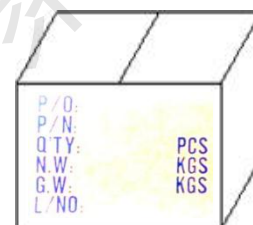
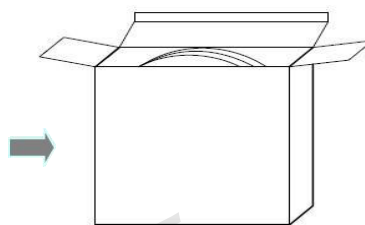
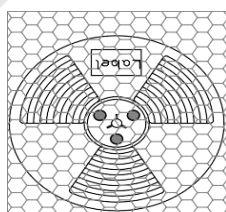
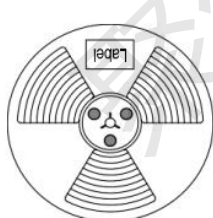
Cover tape peel off condition

1)Cover tape peel force shall be 10 to 120g

2)Noodle strip peeling angle165°to 180°



Packing quantity



Reel

PE袋

Inside Box

Outside Carton

不足整箱用内盒或填充物装满

Part No.	Tape Dimension			Reel Dimensions				REEL (PCS)	Inside Box(PCS)	Outside Carton(PCS)
	W	P	W1	A	B	C	D			
JRH2D09	8	4	3.5	8.4	60	13	180	2000	20,000	120,000
JRH2D11	8	4	3.5	8.4	60	13	180	2000	20,000	120,000
JRH2D14	8	4	3.5	8.4	60	13	180	2000	20,000	120,000
JRH2D18	8	4	3.5	8.4	60	13	180	2000	20,000	120,000
JRH3D11	12	8	3.5	12.4	100	13	330	4000	12,000	48,000
JRH3D14	12	8	5.5	12.4	100	13	330	4000	12,000	48,000
JRH3D16	12	8	5.5	12.4	100	13	330	3000	9,000	36,000
JRH3D28	12	8	5.5	12.4	100	13	330	2000	12,000	24,000
JRH4D18	12	8	5.5	12.4	100	13	330	2000	6,000	24,000
JRH4D28	12	8	5.5	12.4	100	13	330	2000	6,000	24,000
JRH5D18	12	8	5.5	12.4	100	13	330	2000	6000	24,000
JRH5D28	12	8	5.5	12.4	100	13	330	2000	6,000	24,000
JRH6D28	16	12	7.5	16.4	100	13	330	1500	6,000	24,000
JRH6D38	16	12	7.5	16.4	100	13	330	1000	3000	12,000

使用注意事项Reminders For Using These Products

- 保存时间为12个月以内,保存条件(温度5~40°C以下、湿度35~66%RH以下),需充分注意。

若超过保存时间,端子电极的可焊性将可能老化。The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 5~40°C, humidity: 35 to 65% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.

- 请勿在气体腐蚀环境(盐、酸、碱等)下使用和保存。Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).

- 手上的油脂会导致可焊性降低,应避免用手直接接触端子。Don't touch electrodes directly with bare hands as oil secretions may inhibit soldering. Always ensure optimum conditions for soldering.

- 请小心轻拿轻放,避免由于产品的跌落或取出不当而导致的损坏。Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

- 端子过度弯曲会导致断线,请不要过度弯曲端子。Don't bend the terminals with excessive stress in case of any wire fracture.

- 不要清洗产品,如需要清洗时请联系我司。Don't rinse coils by yourself and please contact JXX if necessary.

- 请勿将本产品靠近磁铁或带有磁力的物体。Don't expose the products to magnets or magnetic fields.

- 在实施焊接前,请务必进行预热。预热温度与焊接温度及芯片温度的温度差要在150°C以内。Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.

- 安装后的焊接修正应在规格书规定的条件范围内。若加热过度可能导致短路、性能降低、寿命减少。Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.

- 装置会因通电而自我发热(温度上升),因此在热设计方面需留有充分余地。Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.

- 非磁屏蔽型在基板设计时需注意配置线圈,受到电磁干扰可能会导致误动作。Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.

- 当本公司产品使用在一般电子设备以外的场合,如:车载,医疗设备,军用,航空航天等,请务必联系本公司营业部门,如超出本公司产品使用条件而引起的机器故障时,本公司概不负责。If JXX product will be applied in area like automotive product, medical equipment, military and aerospace except general electronic device, please keep JXX sales informed in advance. JXX shall not be held liable for any malfunction or breakdown caused by using product in the condition which is inconsistent with that recommended by JXX.